TEA1721AT

Ultra-low standby SMPS controller with integrated power switch

Rev. 1 — 24 January 2012

Preliminary data sheet

1. Product profile

1.1 General description

The TEA1721 is a small and low cost module Switched Mode Power Supply (SMPS) controller IC for low power applications (up to 5 W) and operates directly from the rectified universal mains input. The device includes a high voltage power switch (700 V) and has been optimized for flyback converter topologies to provide high-efficiency over the entire load range with ultra-low power consumption in the no-load condition. It provides a circuit for start-up directly from the rectified mains voltage without any external bleeder circuits.

The converter operates as a regulated voltage source from no-load up to the maximum output current and operates as current source that delivers the maximum current over a broad output voltage range. Using the TEA1721, a low power converter can be built at minimum cost and with the minimum number of external components.

The controller regulates the output voltage with primary-side sensing which eliminates the need for an additional secondary feedback circuitry and simplifies the design. At higher power levels, a frequency and current control mode is used. It operates with Burst mode control at low power levels and no-load condition. The burst mode minimizes audible noise and provides an energy saver state which reduces the power consumption in no-load condition. The Burst mode frequency of 430 Hz enables no-load power consumption below < 10 mW at high mains input.

1.2 Features and benefits

Power features:

- Low power SMPS controller with integrated power switch designed for applications up to 5 W
- 700 V high voltage power switch for global mains operation
- Primary sensing for control of the output voltage without optocoupler and secondary feedback circuitry
- Minimizes audible noise in all operation modes
- USB battery charging and Energy Star 2.0 compliant
- Jitter function for reduced EMI



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Green features:

- Enables no-load power consumption below < 10 mW
- Very low supply current in no-load condition with energy saver mode
- Incorporates a high voltage start-up circuit with zero current consumption under normal switching operation
- Available in halogen-free and Restriction of Hazardous Substances (RoHS) SO7 package

Protective functions:

- OverVoltage Protection (OVP) on IC supply pin and on Feedback control (FB) pin with auto-restart
- UnderVoltage LockOut (UVLO) protection on IC supply pin
- OverTemperature Protection (OTP)
- Soft-start by reduced peak current for zero and low output voltage
- Demagnetization protection for guaranteed discontinuous conduction mode operation
- Open and short-circuit protection of the Feedback control (FB) pin

1.3 Applications

- Battery chargers for cellular phones and other low power adapters up to 5 W
- Standby supply for TV and desktop PC
- Power supply for white goods applications

1.4 Quick reference data

Table 1. Quick reference data

Parameter	Conditions	Min	Тур	Max	Unit
Power switch (Pin: DRAIN)					
drain-source on-state resistance	$I_{ds} = 30 \text{ mA}; T_j = 25 \text{ °C}$	-	13.2	-	Ω
Pins: DRAIN and S	SOURCE)				
burst frequency	burst frequency in CVB mode, without jitter	390	430	470	Hz
oscillator frequency High	maximum switching frequency in CV and CC mode, without jitter	48	50.5	53	kHz
n: VCC)					
start-up supply voltage		15	17	19	V
stop supply voltage	undervoltage lockout of IC	7.5	8.5	9.5	V
	ch (Pin: DRAIN) drain-source on-state resistance Pins: DRAIN and \$ burst frequency oscillator frequency High n: VCC) start-up supply voltage stop supply	ch (Pin: DRAIN) drain-source on-state resistance Pins: DRAIN and SOURCE) burst frequency burst frequency in CVB mode, without jitter oscillator maximum switching frequency in CV and CC mode, without jitter i: VCC) start-up supply voltage stop supply undervoltage lockout of IC	ch (Pin: DRAIN) drain-source on-state resistance Pins: DRAIN and SOURCE) burst frequency burst frequency in CVB mode, without jitter oscillator maximum switching frequency in CV and CC mode, without jitter a: VCC) start-up supply voltage stop supply undervoltage lockout of IC	ch (Pin: DRAIN) drain-source on-state resistance Pins: DRAIN and SOURCE) burst frequency burst frequency in CVB mode, without jitter oscillator maximum switching frequency in CV and CC mode, without jitter i: VCC) start-up supply voltage stop supply undervoltage lockout of IC - 13.2	ch (Pin: DRAIN) drain-source on-state resistance Pins: DRAIN and SOURCE) burst frequency burst frequency in CVB mode, without jitter oscillator maximum switching frequency in CV and CC mode, without jitter a: VCC) start-up supply voltage stop supply undervoltage lockout of IC - 13.2 - 13.2 -

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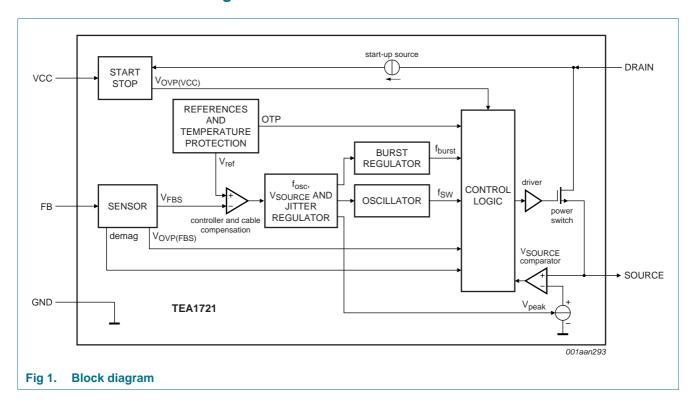
2. Ordering information

Table 2. Ordering information

Type number	Package						
	Name	Description	Version				
TEA1721AT/N1	SO7	plastic small outline package; 7 leads; body width 3.9 mm	SOT1175-1				

3. Block diagram

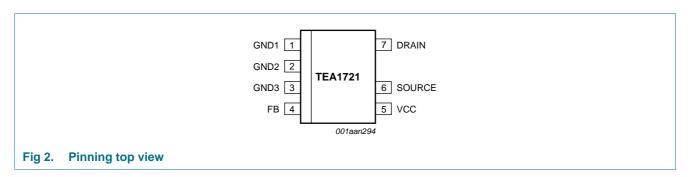
3.1 Block diagram



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4. Pinning information

4.1 Pinning



4.2 Pin description

Pin	Pin name	I/O type	Pin description
1	GND1		ground
2	GND2		ground
3	GND3		ground
4	FB	ı	feedback input for voltage sensing
5	VCC	I	supply input
6	SOURCE	0	source for power switch
7	DRAIN	I	drain of power switch
-	-		high voltage spacer

5. Functional description

5.1 Start-up

The TEA1721 starts up by charging the VCC capacitor until the $V_{CC(start)}$ level. The charging current flows from the high voltage DRAIN pin via an internal start-up current source to the VCC pin.

Once the start level has been reached the start-up current source is switched off. During switching operation, the start-up current source remains current-less and has zero bleeder loss.

5.2 Primary sensing

The FB input senses the reflected secondary voltage on the primary side. The FB input has a sample and hold function that samples the FB voltage on the secondary stroke to control the output voltage.

The sampled V_{FBS} voltage is the input for the TEA1721's control loop and defines the operating mode.

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5.3 Operating modes

The TEA1721 operates in three modes, one of which is active at the time. The three modes in order of decreasing load impedance are:

- CVB: Constant Voltage with Burst mode
- CV: Constant Voltage mode
- CC: Constant Current mode

The converter acts as a voltage source in CVB and CV modes.

The converter acts as a current source in CC mode.

5.3.1 Constant Voltage with Burst mode (CVB)

At low power, the TEA1721 operates in Burst mode.

Burst mode operates with a $V_{SOURCE} = 100$ mV, a switching frequency of 22.5 kHz and burst duty-cycle regulation by sensing the FB voltage.

The TEA1721 features an energy save function that puts the main part of the analogue blocks in a sleep mode with low supply current in burst mode. The burst mode enables the energy save mode in the non-switching part of the burst. The IC switches to the nominal supply just before new burst starts.

Transition from burst mode to CV mode happens at 100 % burst duty cycle: a burst completely filled with 32 pulses. This 100 % pulse train is identical to the lowest power level of the CV mode. The TEA1721 changes directly from burst mode to current mode if the FB voltage drops below 2.4 V in burst mode.

5.3.2 Constant Voltage mode (CV)

At higher power levels, the TEA1721 operates in CV mode. The output voltage is sensed by the FB pin and the control keeps the output voltage constant over the power range.

CV mode starts at 22.5 kHz switching frequency and I_{SOURCE} regulation at the V_{SOURCE} minimum level of 100 mV.

With an increasing power output, the V_{SOURCE} level and the switching frequency are also increased.

CV mode is exited when the maximum power level is reached. Maximum power occurs at I_{SOURCE} regulation at the V_{SOURCE} maximum level of 555 mV and a maximum switching frequency of 50.5 kHz.

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5.3.3 Constant Current mode (CC)

The CC mode starts at maximum power delivery and keeps the output current constant for decreasing output voltage.

CC mode is enabled when the converter is operating at the maximum switching frequency, with the maximum primary peak current when the FB voltage drops below the regulated level.

CC mode operation controlled is by regulation of the switching frequency from 50.5 kHz down to 25 kHz and by I_{SOURCE} regulation from the maximum V_{SOURCE} level of 555 mV until level of V_{SOURCE} is 0.18 V. The V_{SOURCE} level of 0.18 V equals the level at start-up with zero output voltage and the output capacitor discharged.

5.4 Jitter

The TEA1721 features a jitter function for ElectroMagnetic Interference (EMI) reduction. The switching frequency varies between -8~% and +8~% for the spread spectrum. The sweep frequency is a low frequency of approximately 200 Hz. To keep the output power constant, the V_{SOURCE} level is jittered with the opposite polarity. The jitter is active in all operation modes except burst mode.

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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
T _{amb}	ambient temperature			-40	+85	°C
T _j	junction temperature			-40	+150	°C
T _{stg}	storage temperature			-55	+150	°C
V _{ESD}	electrostatic discharge voltage	CDM; all pins		-500	+500	V
		HBM; all pins, except pin 7	<u>[1]</u>	-2000	+2000	V
		HBM; pin 7	<u>[1]</u>	-1000	+1000	V
Voltages						
V _{DRAIN}	voltage on pin DRAIN			-0.3	+700	V
V _{SOURCE}	voltage on pin SOURCE			-0.3	+5	V
V _{CC}	voltage on pin VCC			-0.3	+60	V
V_{FB}	voltage on pin FB			-20	+5	V
Currents						
I _{DRAIN}	current on pin DRAIN			0	0.7	Α
I _{SOURCE}	current on pin SOURCE			-0.7	0	Α
Icc	current on pin VCC			0	20	mA
I _{FB}	current on pin FB			-1	+1	mΑ

^[1] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.

7. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-a)}}$	thermal resistance from junction to	in free air; SO7 package, PCB: 2.5 cm X 3 cm, 2-layer, 70 µm Cu	-	158	-	K/W
	ambient	in free air; SO7 package, PCB: 3 cm X 6 cm, 1-layer, 35 μm Cu	-	130	-	K/W

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8. Characteristics

Table 5. Characteristics

 $V_{CC} = 20 \text{ V}; V_{FB} = 0 \text{ V}; R_{source} = 1.5 \Omega; T_{j\text{-switch}} = 25 \text{ °C}; T_{j\text{-controller}} = 25 \text{ °C}; all voltages referenced to GND, positive currents flow into the IC, unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply (Pin: VC	(C)					
I _{CC(startup)0V}	start-up supply current	V _{CC} = 0 V	-	-1.2	-	mA
I _{CC(startup)17V}	start-up supply current	$V_{CC} = V_{CC(startup)}$	-	-0.7	-	mA
I _{CC(energysave)}	supply current in energy save	V _{FB} = 2.8 V, non-switching	90	130	170	μΑ
I _{CC(50kHz)}	supply current at 50 kHz		530	750	970	μΑ
V _{CC(startup)}	start-up supply voltage		15	17	19	V
$V_{CC(stop)}$	stop supply voltage	undervoltage lockout of IC	7.5	8.5	9.5	V
V _{ovp-VCC}	overvoltage protection voltage level on V_{CC}		40	42	44	V
T _{otp}	overtemperature protection threshold temperature on controller die		-	150	-	°C
T _{otp(hys)}	overtemperature protection temperature hysteresis		-	50	-	°C
Feedback (Pin:	FB)					
V _{ovp-FB}	overvoltage protection voltage level on regulated flyback voltage		3.1	3.2	3.3	V
V _{sense(fb)CVB}	regulated flyback sense voltage in CVB mode		2.5	2.55	2.6	V
V _{sense(fb)} CVB_low	threshold flyback sense voltage for direct transition from CVB mode to CVC mode due to low output	in burst mode operation	-	2.4	-	V
V _{sense(fb)CV}	regulated flyback sense voltage in CV mode		2.5	2.55	2.6	V
V _{th(det)demag(fb)}	demagnetization detection voltage level on FB pin		25	50	75	mV
Oscillator (Pins	: DRAIN and SOURCE)					
f _{burst}	burst frequency	burst frequency in CVB mode, without jitter	390	430	470	Hz
f _{jit} /f _{sw}	jitter frequency to switching frequency ratio	in all operation modes except in burst modes	5	7	9	%

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 Table 5.
 Characteristics ...continued

 V_{CC} = 20 V; V_{FB} = 0 V; R_{source} = 1.5 Ω ; $T_{j\text{-switch}}$ = 25 °C; $T_{j\text{-controller}}$ = 25 °C; all voltages referenced to GND, positive currents flow into the IC, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{osc-high}	oscillator frequency High	maximum switching frequency in CV and CC mode, without jitter	48	50.5	53	kHz
f _{osc-low}	oscillator frequency Low	minimum switching frequency in CV and CC mode, without jitter. Switching frequency in CVB mode	21	22.5	24	kHz
f _{sweep}	jitter sweep frequency	In current source operation	150	200	250	Hz
δ_{max}	maximum duty cycle		72	75	78	%
Power switch	(Pin: DRAIN)					
I _{drain(off)}	off-state drain current	$V_{DRAIN} = 325 \text{ V}$	-	1	-	μΑ
I _{drain(start-up)}	start-up drain current	V _{CC} = 0 V	-	1	-	mA
R _{DSon}	drain-source on-state resistance	$T_j = 25 ^{\circ}\text{C}; I_{ds} = 30 \text{mA}$	-	13.2	-	Ω
$V_{(BR)DS}$	drain-source breakdown voltage		700	-	-	V
Peak current of	comparator (Pin: SOURC	E)				
$t_{d(ocp)}$	overcurrent protection delay time	$dV/dt = 0.2 V/\mu s$	-	100	-	ns
t _{leb}	leading edge blanking time		290	325	360	ns
V _{ref-peak-high}	reference voltage , high peak voltage	in CVF and CCF modes	0.525	0.555	0.585	V
$V_{\text{ref-peak-low}}$	reference voltage , low peak voltage	in CVB mode	0.085	0.1	0.115	V
V _{ref-0 V}	reference voltage at start-up or 0 V feedback voltage	in CCC mode with $V_{FBS} = 0 \text{ V}$	0.18	0.21	0.24	V

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9. Package outline

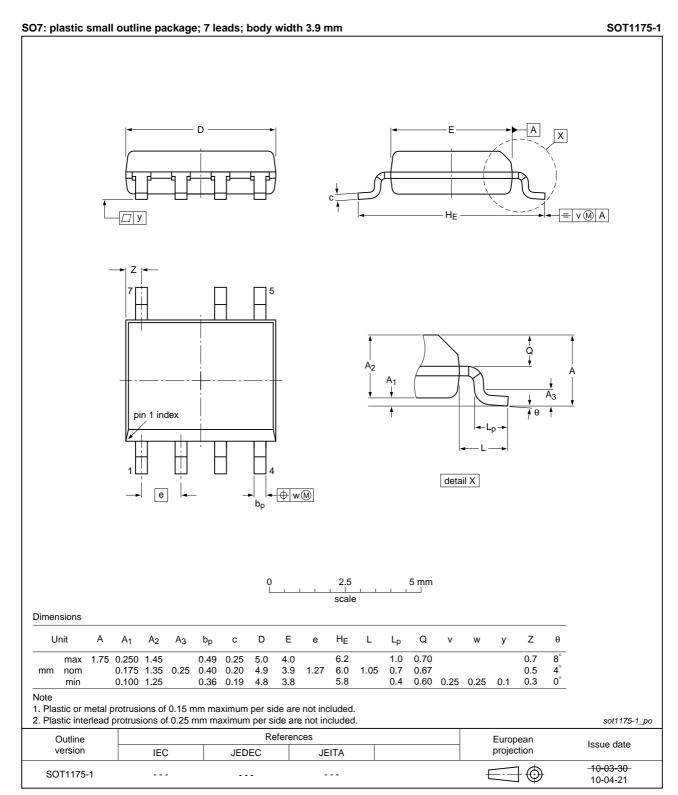


Fig 3. Package outline SOT1175-1 (SO7)

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10. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TEA1721AT v.1	20120124	Preliminary data sheet	-	-

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11.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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